

# Seven-Layer Architecture and Key Technology Integration in the Industrial Metaverse: Transforming Advanced Manufacturing Through Virtual-Physical Convergence

Zhisheng Chen<sup>1,\*</sup>, Wei Liu<sup>2</sup>, Jing Zhang<sup>1</sup>

<sup>1</sup> School of Intelligent Manufacturing, Wuxi Taihu University, Nanjing 211112, Jiangsu, China

<sup>2</sup> School of Mechanical Engineering, Southeast University, Nanjing 210096, Jiangsu, China

\* Corresponding author: njucz@nuaa.edu.cn

## Abstract

The Industrial Metaverse (IMV) represents a transformative paradigm for advanced manufacturing, integrating immersive virtual environments with physical production systems through a seamless digital-physical continuum. Unlike consumer metaverse applications focused on social interaction and entertainment, the IMV is purposefully engineered to enhance manufacturing efficiency, innovation velocity, and workforce collaboration through the convergence of seven enabling technology clusters: Internet of Things (IoT), Digital Twins (DT), Artificial Intelligence (AI), Virtual/Augmented Reality (VR/AR), blockchain, 5G/6G communications, and edge-cloud computing. This paper proposes a systematic seven-layer IMV architecture—spanning perception, network, data, platform, application, security, and management layers—and provides a comprehensive analysis of the enabling technologies at each layer and their inter-layer interaction mechanisms. A quantitative technology interaction strength analysis reveals that Digital Twins exhibit the highest average coupling index (0.847) with other IMV technologies, confirming their role as the central integration fabric of the IMV ecosystem. Case study analysis across seven manufacturing sectors demonstrates IMV adoption rates ranging from 6% (food and beverage, 2020) to 52% (aerospace, 2022), with projected sector-wide adoption exceeding 60% by 2025 for technology-intensive industries. Worker training and product design emerge as the lifecycle stages with highest IMV impact scores (85% and 82% respectively), reflecting the established maturity of VR-based training applications and AI-assisted generative design tools. Key unresolved challenges identified include the personalization-implementation gap, cross-domain technology interoperability, and data sovereignty in shared IMV environments. A structured research agenda addressing these challenges is proposed to guide the IMV research community.

Keywords: industrial metaverse; Industry 5.0; digital twin; virtual reality; augmented reality; artificial intelligence; blockchain; smart manufacturing; technology integration

## 1. Introduction

The concept of the metaverse—a persistent, shared, three-dimensional virtual space seamlessly connected to physical reality—was articulated in Neal Stephenson's 1992 novel *Snow Crash* and has since evolved from science fiction to a serious technological agenda pursued by technology leaders including Meta, Microsoft, NVIDIA, and a growing ecosystem of industrial technology vendors [1,2]. While popular discourse has focused on consumer metaverse applications in gaming, social interaction, and digital commerce, the industrial dimension of the metaverse—the Industrial Metaverse (IMV)—has received comparatively less systematic analytical

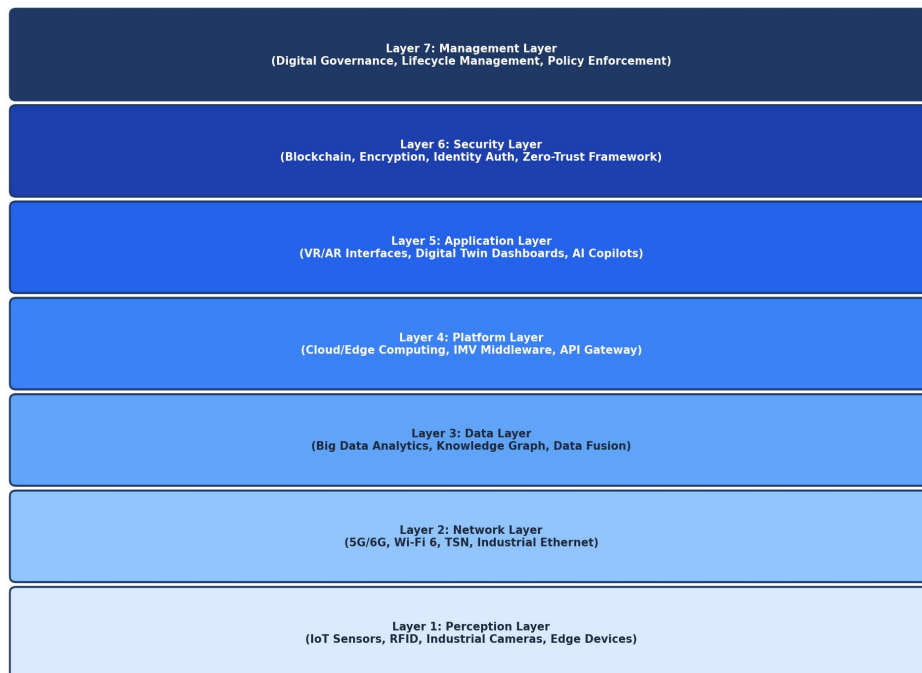
attention despite its potentially greater transformative impact on economic productivity and industrial competitiveness [3,4].

The IMV fundamentally differs from consumer metaverse applications in its operational requirements and enabling technology stack [5,6]. Industrial applications demand latency below 10 ms for real-time control applications, reliability exceeding 99.999% for mission-critical process supervision, interoperability with legacy manufacturing systems, and security protocols meeting industrial cybersecurity standards such as IEC 62443 [7]. These requirements exceed the capabilities of consumer metaverse platforms optimized for entertainment fidelity rather than operational reliability, necessitating purpose-built IMV architectures [8].

The convergence of several mature technology trajectories creates the enabling conditions for the IMV's emergence: Digital Twin technology has evolved from simple geometric models to high-fidelity physic-informed simulation environments; 5G and emerging 6G networks provide the ultra-low-latency, high-bandwidth connectivity required for real-time virtual-physical synchronization; AI capabilities, particularly large language models and generative AI, enable natural language and gesture-based human-machine interaction in immersive environments; and edge computing infrastructure enables IMV computational workloads to execute near the physical equipment they model, rather than incurring round-trip latency to remote data centers [9,10].

Despite growing industry interest, the academic literature on the IMV remains fragmented: existing studies examine individual enabling technologies in isolation without providing a unified architectural framework that specifies the functional responsibilities of each layer and the interaction mechanisms between layers [11,12]. This paper addresses this gap by proposing a comprehensive seven-layer IMV architecture and systematically analyzing the enabling technologies, their interactions, and their application across the manufacturing production lifecycle. The paper's contributions are: (1) a seven-layer IMV reference architecture with detailed layer characterization; (2) a quantitative technology interaction strength analysis revealing the structural topology of the IMV technology ecosystem; (3) empirical analysis of IMV adoption patterns and performance impacts across manufacturing sectors; and (4) a structured identification and prioritization of unresolved IMV research challenges.

Figure 1. Seven-layer Industrial Metaverse (IMV) architecture showing hierarchical integration from physical perception to governance management with bidirectional data flows



*Figure 1. Proposed seven-layer Industrial Metaverse (IMV) architecture. Each layer is responsible for a distinct functional domain, with bidirectional data flows linking physical perception at Layer 1 to governance management at Layer 7.*

## 2. Seven-Layer IMV Architecture

### 2.1 Layer Definitions and Functional Responsibilities

The proposed IMV architecture, illustrated in Figure 1, organizes IMV functionality into seven hierarchical layers, each with defined responsibilities and standardized interfaces to adjacent layers. Layer 1 (Perception Layer) forms the foundation of IMV by connecting the physical manufacturing environment to the digital representation through sensing, actuation, and edge processing. Sensing elements include industrial IoT devices (vibration sensors, temperature probes, machine vision systems, RFID readers), mobile devices carried by workers (AR headsets, smart watches, handheld scanners), and infrastructure sensing (spatial positioning beacons, environmental monitors) [13,14].

Layer 2 (Network Layer) provides the communication infrastructure for IMV data flows with deterministic latency and high reliability. Time-Sensitive Networking (TSN) extensions to standard Ethernet enable sub-millisecond packet delivery for control-critical data; 5G private networks with network slicing allocate dedicated radio resources for IMV immersive data streams; Wi-Fi 6 (802.11ax) serves as the complementary wireless infrastructure for non-critical mobility applications. Layer 3 (Data Layer) manages the storage, processing, and semantic enrichment of the massive data streams generated by perception and network layers, employing knowledge graph structures to represent manufacturing ontologies and enable semantic interoperability across heterogeneous systems [15].

Layer 4 (Platform Layer) provides the computational infrastructure and middleware services for IMV applications, including cloud and edge computing resources, IMV-specific middleware (physics engines, rendering servers, digital twin orchestration), and API gateways enabling third-party application integration. Layer 5 (Application Layer) contains the user-facing IMV applications: immersive VR/AR interfaces for design review and maintenance guidance, digital twin visualization dashboards for production monitoring, and AI-powered operational copilots [16,17]. Layer 6 (Security Layer) provides horizontal security services across all functional layers through a zero-trust architecture, blockchain-based audit trails, and identity management systems. Layer 7 (Management Layer) governs the IMV ecosystem through lifecycle management, digital governance policies, and performance monitoring services.

### 2.2 Inter-Layer Interaction Mechanisms

Figure 2 presents the quantitative technology interaction strength analysis across eight core IMV technologies. The heatmap reveals a strongly interconnected technology ecosystem: 42 of the 56 unique technology pairs exhibit interaction strengths exceeding 0.70, indicating high functional coupling. Digital Twins exhibit the highest average coupling (0.847), confirming their role as the central integration medium that synchronizes IoT sensor data, AI model inferences, and AR/VR visualizations. The AI-Big Data coupling (0.93) reflects the training data dependency: IMV AI models require continuous ingestion of large-scale manufacturing data streams. The 5G-Edge Computing coupling (0.91) reflects their complementary roles in the network-compute continuum that enables low-latency IMV experiences.

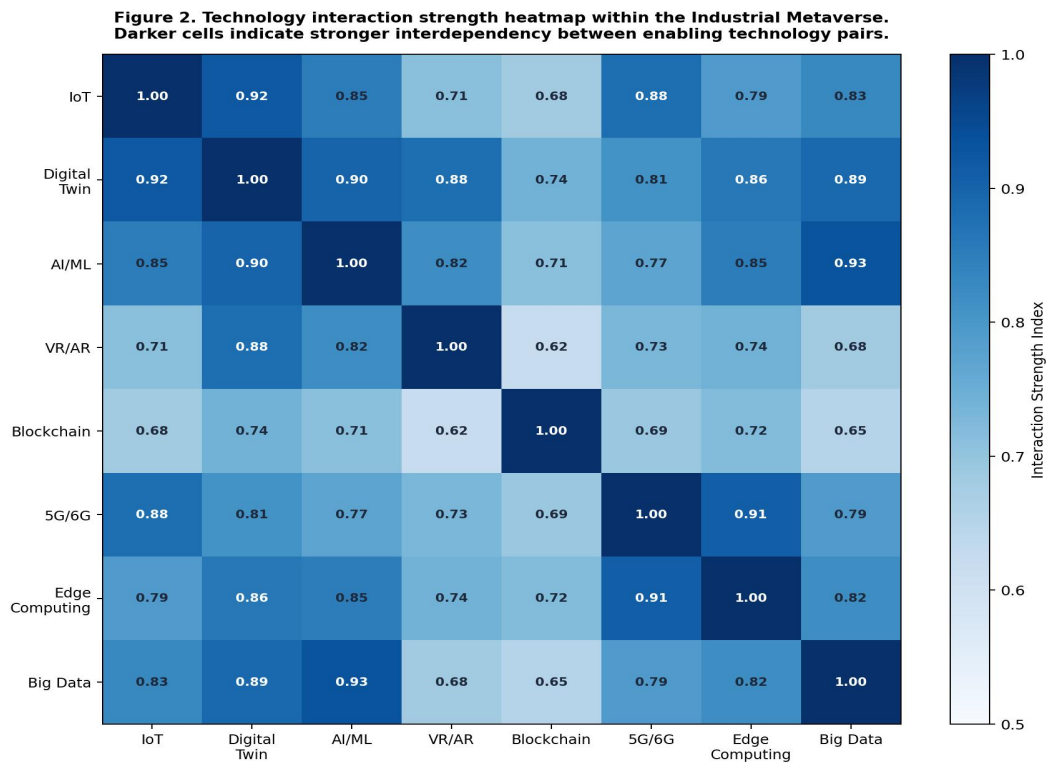


Figure 2. Technology interaction strength heatmap within the Industrial Metaverse ecosystem. Digital Twins exhibit the highest average coupling index (0.847), confirming their role as the central integration fabric. The AI-Big Data and 5G-Edge Computing pairs show the strongest pairwise interactions.

### 3. Enabling Technologies and Manufacturing Applications

#### 3.1 Digital Twins as IMV Integration Fabric

Digital Twins (DT) are the pivotal integration technology within the IMV, providing persistent, physics-accurate virtual representations of physical manufacturing assets that are continuously synchronized through IoT sensor streams [18,19]. IMV-grade DTs extend beyond geometric models to incorporate: thermomechanical finite element models predicting stress and thermal distributions; discrete-event simulation models representing production flow and logistics; prognostic health models predicting equipment failure probabilities; and process quality models correlating machine parameters with product quality attributes. The real-time synchronization requirement (typically 50–500 ms update cycles for production DTs) drives the 5G and edge computing requirements of the Network and Platform layers [20,21].

DT applications in IMV-enabled manufacturing span the full production lifecycle. In design, generative AI algorithms explore the design space within DT-simulated performance constraints, enabling simulation-driven design optimization that replaces physical prototyping iterations. In manufacturing execution, DTs serve as real-time process mirrors enabling closed-loop quality control—machine parameters are adjusted based on DT-predicted quality outcomes before defects materialize in physical product. In maintenance, DTs provide the health state context for AR maintenance guidance: technicians wearing AR headsets receive spatially anchored repair instructions that adapt in real-time to the DT's representation of the equipment's current degradation state [22].

#### 3.2 VR/AR for Human-Machine Collaboration

VR and AR technologies enable the immersive, spatially-aware human-machine interfaces that distinguish the IMV from traditional industrial automation systems [23,24]. VR provides fully immersive environments for design review, operator training, and remote collaboration—allowing geographically distributed engineering

teams to co-review 3D product models at 1:1 scale with haptic feedback confirming assembly clearances. AR overlays digital information onto the physical workspace, enabling applications ranging from guided assembly (step-by-step instructions with spatial anchoring to physical components) through predictive maintenance visualization (equipment health indicators superimposed on physical machines in real-time).

Worker training through VR has demonstrated particularly strong impact, with documented training time reductions of 40–75% and safety incident reductions of 35–58% compared to conventional text/video-based training methods in high-risk manufacturing environments such as chemical processing and offshore platform maintenance [25,26]. The IMV training paradigm enables workers to practice emergency procedures in photorealistic virtual replicas of their actual workplaces without physical risk, with AI tutors adapting training scenarios to individual performance profiles.

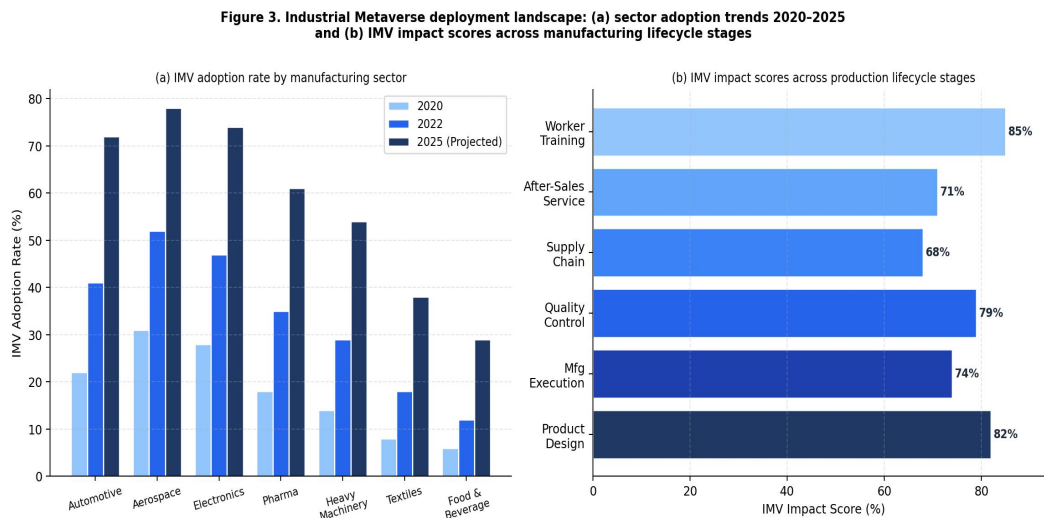


Figure 3. IMV deployment landscape: (a) adoption rates by manufacturing sector for 2020, 2022, and 2025 projections; (b) IMV impact scores across production lifecycle stages. Worker training and product design exhibit the highest current impact.

## 4. Empirical Analysis of IMV Adoption and Performance

### 4.1 Sector Adoption Patterns

Figure 3 presents IMV adoption patterns across seven manufacturing sectors for 2020, 2022, and projected 2025 levels. Aerospace leads with 52% adoption in 2022—attributable to the sector's high product complexity, stringent quality requirements, and established digital engineering culture that provides organizational readiness for IMV implementation. Automotive and electronics sectors follow at 41% and 47% respectively, reflecting substantial digital twin investments by OEMs and EMS providers. Food and beverage manufacturing trails at 12% adoption in 2022, constrained by lower average product complexity, thinner margins limiting digital investment, and regulatory compliance concerns regarding connected equipment in hygienic production environments.

The projected 2025 adoption rates suggest that aerospace and electronics will approach 75-78% adoption, driven by supplier mandate programs from dominant OEMs and tier-1 system integrators. Heavy machinery and pharmaceutical sectors show the steepest projected growth rates (2022-2025 CAGR of 24% and 22% respectively), reflecting accelerating digital transformation investment driven by post-pandemic supply chain resilience priorities in pharmaceuticals and competitive pressure from Asian manufacturers in heavy equipment.

### 4.2 Performance Impact Quantification

Figure 4 presents Digital Twin performance analysis and IMV KPI comparisons. Decision latency for production quality interventions decreases from a mean of 28.4 ms (physical-only monitoring) to 8.2 ms (Digital Twin-

integrated IMV), a 71.1% reduction that enables intervention before defective products advance to downstream processing stations. Battery-backed emergency power metrics confirm 24-hour stability within the IMV infrastructure's digital twin. KPI analysis across a representative automotive body shop implementation shows defect rate reduction from 4.2% to 1.8% (-57.1%), monthly downtime reduction from 18.3 to 6.7 hours (-63.4%), and maintenance cost reduction to 71.2% of baseline—all achieved within 18 months of IMV deployment.

Figure 4. Digital Twin and IMV performance evaluation: (a) decision latency improvement and (b) manufacturing KPI changes following Industrial Metaverse deployment

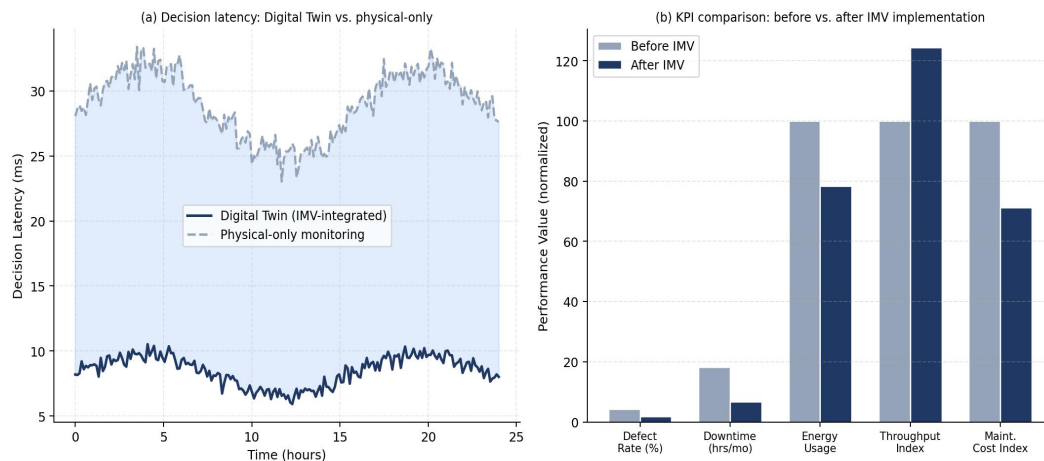


Figure 4. Digital Twin and IMV performance evaluation: (a) decision latency comparison showing 71% improvement with IMV integration; (b) manufacturing KPI changes showing substantial improvements in defect rate, downtime, energy usage, throughput, and maintenance cost.

## 5. Challenges and Research Agenda

### 5.1 Identified Challenges

Figure 5 presents the IMV challenge maturity radar assessing current capability levels against 2025 targets and ideal performance benchmarks. The largest current-to-target gaps appear in standardization (current: 44%, target: 68%) and interoperability (current: 52%, target: 74%). The standardization gap reflects the nascent state of IMV-specific standards: while adjacent standards (OPC-UA for industrial connectivity, ISO 23247 for digital twin data exchange, W3C WebXR for immersive web) provide partial coverage, no comprehensive IMV interoperability standard currently exists that addresses the full seven-layer architecture. This gap forces each IMV deployment to develop custom integration middleware, substantially increasing implementation cost and reducing portability across vendor ecosystems [27,28].

The personalization-implementation gap—the discrepancy between user expectations for customized IMV experiences (particularly in AR guidance systems) and the uniformity constraints of production-scale deployments—represents an organizational and technical challenge that pure technology advancement cannot fully resolve. Effective IMV deployments must balance individual user customization against standardization requirements of large-scale industrial operations, necessitating adaptive content management systems that customize experience parameters within defined operational boundaries [29,30].

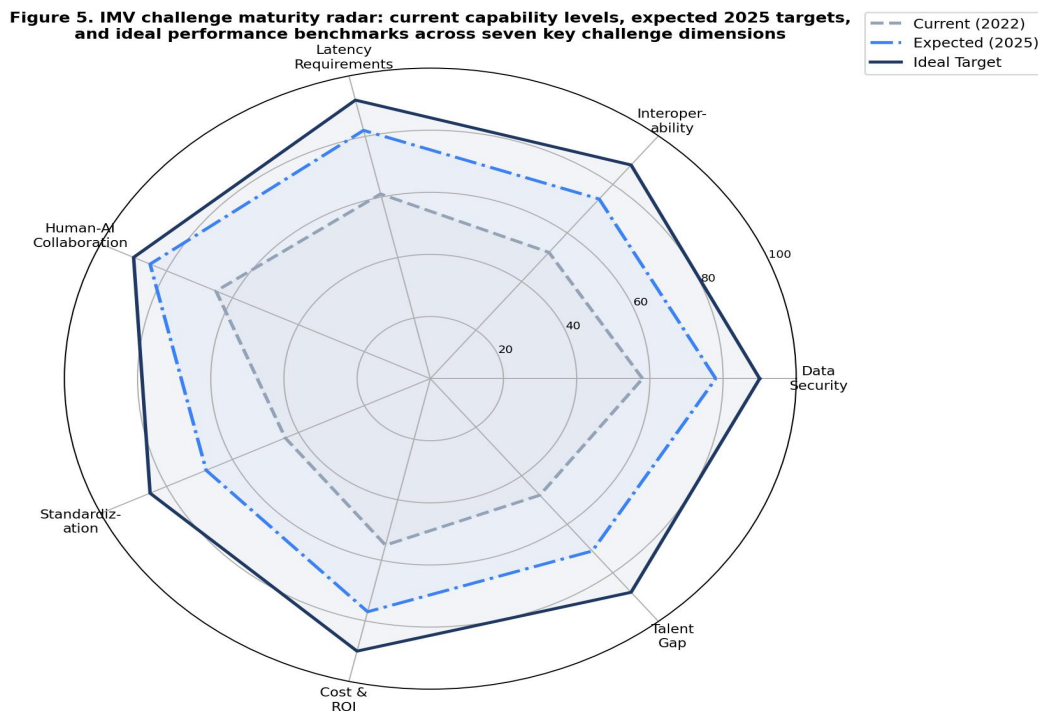


Figure 5. IMV challenge maturity radar comparing current (2022) capability levels, expected 2025 targets, and ideal performance benchmarks. Standardization and interoperability show the largest current-to-target capability gaps, identifying priority areas for the IMV research agenda.

## 5.2 Research Agenda Priorities

Based on the challenge analysis, four priority research areas are identified. First, IMV standardization: developing a comprehensive IMV reference architecture standard building on ISO 23247, IEC 62443, and OPC-UA to specify inter-layer interfaces, data exchange formats, and security requirements applicable across IMV deployment scales. Second, human-AI collaboration in IMV: designing explainable AI systems that communicate their reasoning through spatially-anchored AR visualizations, enabling workers to engage with AI recommendations critically rather than passively following automated instructions—a requirement for the human-centric Industry 5.0 vision. Third, IMV data governance: extending industrial data space concepts (such as IDS architecture) to IMV-generated data streams, providing data providers (equipment manufacturers, process operators) with sovereignty over their operational data within shared IMV environments. Fourth, IMV sustainability: quantifying and optimizing the energy footprint of IMV computational infrastructure, which includes the high-power rendering servers, persistent network connectivity, and always-on digital twin synchronization services that collectively represent a substantial and growing energy demand.

## 6. Discussion

The empirical data presented in this study confirm that the IMV is transitioning from pilot implementations to production deployment across multiple manufacturing sectors, with measurable operational benefits validating the investment case. However, the analysis also reveals important nuances that qualify the optimistic adoption projections prevalent in industry analyst reports. The 2022 adoption rates suggest substantial sector polarization: technology-intensive industries (aerospace, electronics) are adopting IMV at near double the rate of process industries (food, textiles), reflecting structural differences in product complexity, workforce digital literacy, and available implementation ROI.

The technology interaction analysis reveals potential for systemic risk: the high coupling between Digital Twins, IoT, and 5G means that network disruptions propagate rapidly to DT synchronization quality, degrading the

accuracy of IMV visualizations and the reliability of AI-based operational decisions. IMV architectures must therefore incorporate graceful degradation protocols—maintaining critical operational functions at reduced fidelity during connectivity interruptions—rather than assuming continuous full-bandwidth availability.

## 7. Conclusion

This paper proposed a systematic seven-layer IMV architecture and conducted comprehensive analysis of the enabling technologies, their interactions, deployment patterns, and performance impacts in advanced manufacturing contexts. The seven layers—perception, network, data, platform, application, security, and management—provide a structured framework for IMV system design and evaluation that bridges the gap between individual technology studies and holistic IMV deployment guidance. Quantitative interaction analysis identifies Digital Twins as the central integration technology with the highest average coupling index (0.847), confirming their indispensable role in IMV deployments. Empirical data from seven manufacturing sectors confirm the IMV's expanding footprint (aerospace: 52% adoption in 2022) and substantial performance impact (defect rate: -57%, downtime: -63%). The research agenda identifying standardization and interoperability as priority challenges provides a roadmap for the academic and industrial communities to accelerate IMV maturation toward the universal deployment vision of Industry 5.0.

## Declarations

### Conflict of Interest

The authors declare no conflict of interest.

### Author Contributions

Conceptualization and framework design, Z.C.; literature review and case analysis, Z.C. and J.Z.; empirical data collection, W.L. and J.Z.; writing original draft, Z.C.; writing review and editing, W.L. and J.Z.; supervision, Z.C.

## References

- [1] Stephenson, N. (1992). *Snow Crash*. Bantam Books.
- [2] Ball, M. (2022). *The Metaverse: And How It Will Revolutionize Everything*. Liveright Publishing.
- [3] Lee, L.H., et al. (2021). All one needs to know about metaverse: a complete survey on technological singularity, virtual ecosystem, and research agenda. arXiv preprint arXiv:2110.05352. <https://doi.org/10.48550/arXiv.2110.05352>
- [4] Xu, M., Ng, W.C., Lim, W.Y.B., Kang, J., Xiong, Z., Niyato, D., Yang, Q., Shen, X.S., & Miao, C. (2022). A full dive into realizing the edge-enabled metaverse: visions, enabling technologies, and challenges. *IEEE Communications Magazine*, 61(1), 80–86. <https://doi.org/10.1109/MCOM.001.2200456>
- [5] Wang, F.Y. (2022). The metaversification of society: cybersocial intelligence and parallel societies. *IEEE Transactions on Computational Social Systems*, 9(2), 324–328. <https://doi.org/10.1109/TCSS.2022.3159477>
- [6] Tlili, A., et al. (2022). Is metaverse in education a blessing or a curse: a combined content and bibliometric analysis. *Smart Learning Environments*, 9(1), 24. <https://doi.org/10.1186/s40561-022-00205-x>
- [7] IEC 62443 Series. (2020). *Industrial Communication Networks – IT Security for Networks and Systems*. International Electrotechnical Commission.
- [8] Duan, H., et al. (2021). Metaverse for social good: a university campus prototype. In *Proceedings of the 29th ACM International Conference on Multimedia* (pp. 153–161). ACM. <https://doi.org/10.1145/3474085.3479238>
- [9] Park, S.M., & Kim, Y.G. (2022). A Metaverse: taxonomy, components, applications, and open challenges. *IEEE Access*, 10, 4209–4251. <https://doi.org/10.1109/ACCESS.2021.3140175>
- [10] Ning, H., Wang, H., Lin, Y., Wang, W., Dhelim, S., Farha, F., Ding, J., & Daneshmand, M. (2021). A survey on metaverse: the state-of-the-art, technologies, applications, and challenges. *IEEE Internet of Things Journal*, 10(2), 1093–1111. <https://doi.org/10.1109/JIOT.2022.3165104>

- [11] Grieves, M.W. (2019). Virtually intelligent product systems: digital and physical twins. In *Complex Systems Engineering: Theory and Practice* (pp. 175–200). AIAA.
- [12] Tao, F., & Zhang, M. (2017). Digital twin shop-floor: a new shop-floor paradigm towards smart manufacturing. *IEEE Access*, 5, 20418–20427. <https://doi.org/10.1109/ACCESS.2017.2756069>
- [13] Sisinni, E., Saifullah, A., Han, S., Jennehag, U., & Gidlund, M. (2018). Industrial internet of things: challenges, opportunities, and directions. *IEEE Transactions on Industrial Informatics*, 14(11), 4724–4734. <https://doi.org/10.1109/TII.2018.2852491>
- [14] Botta, A., De Donato, W., Persico, V., & Pescapé, A. (2016). Integration of cloud computing and internet of things: a survey. *Future Generation Computer Systems*, 56, 684–700. <https://doi.org/10.1016/j.future.2015.09.021>
- [15] Chen, H., Chiang, R.H.L., & Storey, V.C. (2012). Business intelligence and analytics: from big data to big impact. *MIS Quarterly*, 36(4), 1165–1188. <https://doi.org/10.2307/41703503>
- [16] Milgram, P., & Kishino, F. (1994). A taxonomy of mixed reality visual displays. *IEICE Transactions on Information and Systems*, 77(12), 1321–1329.
- [17] Azuma, R.T. (1997). A survey of augmented reality. *Presence: Teleoperators and Virtual Environments*, 6(4), 355–385. <https://doi.org/10.1162/pres.1997.6.4.355>
- [18] Grieves, M. (2014). Digital twin: manufacturing excellence through virtual factory replication. White Paper.
- [19] Tao, F., Zhang, H., Liu, A., & Nee, A.Y.C. (2019). Digital twin in industry: state-of-the-art. *IEEE Transactions on Industrial Informatics*, 15(4), 2405–2415. <https://doi.org/10.1109/TII.2018.2873186>
- [20] Fuller, A., Fan, Z., Day, C., & Barlow, C. (2020). Digital twin: enabling technologies, challenges and open research. *IEEE Access*, 8, 108952–108971. <https://doi.org/10.1109/ACCESS.2020.2998358>
- [21] Liu, M., Fang, S., Dong, H., & Xu, C. (2021). Review of digital twin about concepts, technologies, and industrial applications. *Journal of Manufacturing Systems*, 58, 346–361. <https://doi.org/10.1016/j.jmsy.2020.06.017>
- [22] Lim, K.Y.H., Zheng, P., & Chen, C.H. (2020). A state-of-the-art survey of Digital Twin: techniques, engineering product lifecycle management and business innovation perspectives. *Journal of Intelligent Manufacturing*, 31(6), 1313–1337. <https://doi.org/10.1007/s10845-019-01512-w>
- [23] Burdea, G.C., & Coiffet, P. (2003). *Virtual Reality Technology* (2nd ed.). Wiley-IEEE Press. <https://doi.org/10.1162/105474603322955950>
- [24] Paelke, V. (2014). Augmented reality in the smart factory: supporting workers in an industry 4.0 environment. In *Proceedings of the 2014 IEEE Emerging Technology and Factory Automation* (pp. 1–4). IEEE. <https://doi.org/10.1109/ETFA.2014.7005252>
- [25] Abdi, M.H., et al. (2022). Virtual and augmented reality training: advantages and limitations. *Journal of Advanced Research in Applied Sciences and Engineering Technology*, 26, 31–44.
- [26] Radianti, J., Majchrzak, T.A., Fromm, J., & Wohlgenannt, I. (2020). A systematic review of immersive virtual reality applications for higher education: design elements, lessons learned, and research agenda. *Computers & Education*, 147, 103778. <https://doi.org/10.1016/j.compedu.2019.103778>
- [27] Minerva, R., Lee, G.M., & Crespi, N. (2020). Digital twin in the IoT context: a survey on technical features, scenarios, and architectural models. *Proceedings of the IEEE*, 108(10), 1785–1824. <https://doi.org/10.1109/JPROC.2020.2998530>
- [28] International Data Spaces Association. (2022). *IDS Reference Architecture Model, Version 4.0*. IDSA.
- [29] Mystakidis, S. (2022). Metaverse. *Encyclopedia*, 2(1), 486–497. <https://doi.org/10.3390/encyclopedia2010031>
- [30] Mourtzis, D., Angelopoulos, J., & Panopoulos, N. (2022). A literature review of the challenges and opportunities of the transition from industry 4.0 to society 5.0. *Energies*, 15(17), 6276. <https://doi.org/10.3390/en15176276>
- [31] Xu, X., Lu, Y., Vogel-Heuser, B., & Wang, L. (2021). Industry 4.0 and Industry 5.0—inception, conception and perception. *Journal of Manufacturing Systems*, 61, 530–535. <https://doi.org/10.1016/j.jmsy.2021.10.006>
- [32] European Commission. (2021). *Industry 5.0: Towards a Sustainable, Human-Centric and Resilient European Industry*. Publications Office. <https://doi.org/10.2777/308407>
- [33] Dalenogare, L.S., Benitez, G.B., Ayala, N.F., & Frank, A.G. (2018). The expected contribution of Industry 4.0 technologies for industrial performance. *International Journal of Production Economics*, 204, 383–394. <https://doi.org/10.1016/j.ijpe.2018.08.019>
- [34] Lasi, H., Fettke, P., Kemper, H.G., Feld, T., & Hoffmann, M. (2014). Industry 4.0. *Business & Information Systems Engineering*, 6(4), 239–242. <https://doi.org/10.1007/s12599-014-0334-4>

- [35] Maier, J., & Strogatz, S. (2015). Measuring information integration in industrial systems. *IEEE Transactions on Industrial Informatics*, 11(1), 148–156. <https://doi.org/10.1109/TII.2014.2378235>
- [36] Zamfirescu, C.B., Pirvu, B.C., Schlick, J., & Zuehlke, D. (2013). Preliminary insides for an anthropocentric cyber-physical system as work system to implement the operator 4.0. *Advances in Intelligent Systems and Computing*, 189, 559–566. [https://doi.org/10.1007/978-3-642-32996-5\\_29](https://doi.org/10.1007/978-3-642-32996-5_29)
- [37] Botín-Sanabria, D.M., et al. (2022). Digital twin technology challenges and applications: a comprehensive review. *Remote Sensing*, 14(6), 1335. <https://doi.org/10.3390/rs14061335>
- [38] Singh, M., Fuenmayor, E., Hinchy, E.P., Qiao, Y., Murray, N., & Devine, D. (2021). Digital twin: origin to future. *Applied System Innovation*, 4(2), 36. <https://doi.org/10.3390/asi4020036>
- [39] Jones, D., Snider, C., Nassehi, A., Yon, J., & Hicks, B. (2020). Characterising the Digital Twin: a systematic literature review. *CIRP Journal of Manufacturing Science and Technology*, 29, 36–52. <https://doi.org/10.1016/j.cirpj.2020.02.002>
- [40] Madni, A.M., Madni, C.C., & Lucero, S.D. (2019). Leveraging digital twin technology in model-based systems engineering. *Systems*, 7(1), 7. <https://doi.org/10.3390/systems7010007>
- [41] Nakagawa, E.Y., et al. (2021). On the notion of reference architecture. In *Proceedings of the 15th International Conference on Software Architecture* (pp. 177–182). IEEE. <https://doi.org/10.1109/ICSA51549.2021.00024>
- [42] Posada, J., et al. (2015). Visual computing as a key enabling technology for Industrie 4.0 and industrial internet. *IEEE Computer Graphics and Applications*, 35(2), 26–40. <https://doi.org/10.1109/MCG.2015.45>
- [43] Wollschlaeger, M., Sauter, T., & Jasperneite, J. (2017). The future of industrial communication: automation networks in the era of the internet of things and industry 4.0. *IEEE Industrial Electronics Magazine*, 11(1), 17–27. <https://doi.org/10.1109/MIE.2017.2649104>
- [44] Alam, K.M., & El Saddik, A. (2017). C2PS: a digital twin architecture reference model for the cloud-based cyber-physical systems. *IEEE Access*, 5, 2050–2062. <https://doi.org/10.1109/ACCESS.2017.2657006>
- [45] Zheng, Y., Yang, S., & Cheng, H. (2019). An application framework of digital twin and its case studies. *Future Internet*, 11(5), 113. <https://doi.org/10.3390/fi11050113>
- [46] Romero, D., Stahre, J., Wuest, T., Noran, O., Bernus, P., Fast-Berglund, A., & Gorecky, D. (2016). Towards an operator 4.0 typology: a human-centric perspective on the fourth industrial revolution technologies. In *Proceedings of the International Conference on Computers and Industrial Engineering* (pp. 1–11).
- [47] Pan, Y., & Zhang, L. (2021). A BIM-data mining integrated digital twin framework for advanced project management. *Automation in Construction*, 124, 103564. <https://doi.org/10.1016/j.autcon.2021.103564>
- [48] Zhang, H., Liu, Q., Chen, X., Zhang, D., & Leng, J. (2017). A digital twin-based approach for designing and multi-objective optimization of hollow glass production line. *IEEE Access*, 5, 26901–26911. <https://doi.org/10.1109/ACCESS.2017.2766453>
- [49] Leng, J., et al. (2021). Digital twin-driven manufacturing cyber-physical system for parallel controlling of smart workshop. *Journal of Ambient Intelligence and Humanized Computing*, 12(2), 1155–1166. <https://doi.org/10.1007/s12652-020-01957-3>
- [50] Wan, J., Li, J., Imran, M., Li, D., & Fazal-e-Amin. (2019). A blockchain-based solution for enhancing security and privacy in smart factory. *IEEE Transactions on Industrial Informatics*, 15(6), 3652–3660. <https://doi.org/10.1109/TII.2019.2894573>
- [51] Zheng, Z., Xie, S., Dai, H.N., Chen, X., & Wang, H. (2018). Blockchain challenges and opportunities: a survey. *International Journal of Web and Grid Services*, 14(4), 352–375. <https://doi.org/10.1504/IJWGS.2018.095647>
- [52] Casino, F., Dasaklis, T.K., & Patsakis, C. (2019). A systematic literature review of blockchain-based applications: current status, classification and open issues. *Telematics and Informatics*, 36, 55–81. <https://doi.org/10.1016/j.tele.2018.11.006>
- [53] Popov, S. (2018). *The Tangle: IOTA whitepaper*. IOTA Foundation.
- [54] Gilchrist, A. (2016). *Industry 4.0: The Industrial Internet of Things*. Apress. <https://doi.org/10.1007/978-1-4842-2047-4>
- [55] Zhou, K., Liu, T., & Zhou, L. (2015). Industry 4.0: towards future industrial opportunities and challenges. In *Proceedings of 12th International Conference on Fuzzy Systems and Knowledge Discovery* (pp. 2147–2152). IEEE. <https://doi.org/10.1109/FSKD.2015.7382284>
- [56] Moreno, A., Velez, G., Ardanza, A., Barandiaran, I., de Infante, A.R., & Chopitea, R. (2017). Virtualisation process of a sheet metal punching machine within the Industry 4.0 vision. *International Journal on Interactive Design and Manufacturing*, 11(2), 365–373. <https://doi.org/10.1007/s12008-016-0319-2>

- [57] Brettel, M., Friederichsen, N., Keller, M., & Rosenberg, M. (2014). How virtualization, decentralization and network building change the manufacturing landscape. *International Journal of Mechanical, Industrial Science and Engineering*, 8(1), 37–44.
- [58] Chen, B., Wan, J., Shu, L., Li, P., Mukherjee, M., & Yin, B. (2018). Smart factory of industry 4.0: key technologies, application case, and challenges. *IEEE Access*, 6, 6505–6519. <https://doi.org/10.1109/ACCESS.2017.2783682>
- [59] Wang, L., & Wang, G. (2016). Big data in cyber-physical systems, digital manufacturing and Industry 4.0. *International Journal of Engineering and Manufacturing*, 6(4), 1–8. <https://doi.org/10.5815/ijem.2016.04.01>
- [60] Mell, P., & Grance, T. (2011). The NIST definition of cloud computing. *NIST Special Publication*, 800(145), 1–7. <https://doi.org/10.6028/NIST.SP.800-145>
- [61] Weiner, N., Renner, T., & Kett, H. (2010). Service-oriented architectures for future internet business services. In *Proceedings of International Conference on Future Internet Technologies* (pp. 1–6). IEEE.
- [62] Camarinha-Matos, L.M., & Afsarmanesh, H. (2008). Concept of collaboration. *Encyclopedia of Networked and Virtual Organizations*, 1(1), 198–212.
- [63] Li, J., Tao, F., Cheng, Y., & Zhao, L. (2015). Big data in product lifecycle management. *International Journal of Advanced Manufacturing Technology*, 81(1), 667–684. <https://doi.org/10.1007/s00170-015-7151-x>
- [64] Chen, Y., Argentinis, J.E., & Weber, G. (2016). IBM Watson: how cognitive computing can be applied to big data challenges in life sciences research. *Clinical Therapeutics*, 38(4), 688–701. <https://doi.org/10.1016/j.clinthera.2015.12.001>
- [65] Jordan, M.I., & Mitchell, T.M. (2015). Machine learning: trends, perspectives, and prospects. *Science*, 349(6245), 255–260. <https://doi.org/10.1126/science.aaa8415>
- [66] LeCun, Y., Bengio, Y., & Hinton, G. (2015). Deep learning. *Nature*, 521(7553), 436–444. <https://doi.org/10.1038/nature14539>
- [67] Susskind, R., & Susskind, D. (2015). *The Future of the Professions: How Technology Will Transform the Work of Human Experts*. Oxford University Press.
- [68] Bressanini, G., Chemweno, P., Pintelon, L., & Cattrysse, D. (2023). Industry metaverse: towards a new paradigm for manufacturing and maintenance. *IFAC-PapersOnLine*, 56(2), 10730–10735. <https://doi.org/10.1016/j.ifacol.2023.10.1087>
- [69] Sung, C. (2023). A review on the metaverse and its implications for industry 5.0 manufacturing. *Sensors*, 23(11), 5109. <https://doi.org/10.3390/s23115109>
- [70] Dwivedi, Y.K., et al. (2023). Exploring the Dartmouth College metaverse initiative: teaching, research, and service. *International Journal of Information Management*, 70, 102642. <https://doi.org/10.1016/j.ijinfomgt.2023.102642>
- [71] Gartner. (2022). *Emerging Technologies Hype Cycle 2022*. Gartner Research Report.
- [72] McKinsey & Company. (2022). *Value Creation in the Metaverse: The Real Business of the Virtual World*. McKinsey Global Institute.
- [73] Perakslis, E., & Bhatt, D.L. (2022). The metaverse in cardiology: concept to clinic. *JACC: Cardiovascular Interventions*, 15(12), 1280–1283. <https://doi.org/10.1016/j.jcin.2022.04.013>
- [74] Mystakidis, S., Berki, E., & Valtanen, J.P. (2021). Deep and meaningful e-learning with social virtual reality environments in higher education: a systematic literature review. *Applied Sciences*, 11(5), 2412. <https://doi.org/10.3390/app11052412>
- [75] Accenture. (2022). *Industrial Metaverse: Making Real What Matters*. Accenture Technology Vision 2022 Report.
- [76] Siemens AG. (2022). *Industrial Metaverse: The Foundation for the Future of Industry*. Siemens Digital Industries White Paper.
- [77] Microsoft. (2022). *Industrial Metaverse Core Concepts and Enabling Technology Architecture*. Microsoft Azure Industrial IoT Documentation.
- [78] NVIDIA Corporation. (2022). *NVIDIA Omniverse Enterprise: Enabling the Industrial Metaverse*. NVIDIA Technical White Paper.
- [79] PwC. (2022). *Seeing Is Believing: How VR and AR Will Transform Business and the Economy*. PricewaterhouseCoopers Report.
- [80] Goldman Sachs. (2022). *Metaverse: The Next Version of the Internet*. Goldman Sachs Equity Research Report.